

CONTACT

📍 San Diego, CA

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SKILLS

schematic & pcb

board bringup

product dev

3d modeling

soldering

EDDIE SAMUELS

EXPERIENCE

comma.ai 2016 – now

VP of Hardware

- hardware development of the eon, panda, & secret projects
- process design & parts sourcing for production of 10k units
- enclosure design with a 3D printed focus
- android/linux kernel support for Qualcomm Snapdragon
- user facing packaging design & production

Lockheed Martin 2015 – 2016

Associate Electrical Engineer

- pcb bring up and documentation for test equipment
- development of MATLAB software to search for RF spurs

Lockheed Martin summer 2014

Electrical Engineer Intern

- joint program with the New York NASA Space Grant Consortium
- development of underwater rover and corresponding curriculum for STEM outreach program

EDUCATION

University of Rochester 2011 – 2015

B.S. in Electrical & Computer Engineering